BLF2043

UHF power LDMOS transistor

Rev. 7 — 1 September 2015



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Thank you for your cooperation and understanding,

Ampleon

DESCRIPTION

UHF power LDMOS transistor

FEATURES

- Typical 2-tone performance at a supply voltage of 26 V and I_{DQ} of 85 mA:
 - Output power = 10 W (PEP)
 - Gain = 12 dB
 - Efficiency = 36.5%
 - dim = -32 dBc
- · Easy power control
- Excellent ruggedness
- High power gain
- · Excellent thermal stability
- Designed for broadband operation (HF to 2200 MHz)
- No internal matching for broadband operation.

APPLICATIONS

- RF power amplifiers for GSM, EDGE and CDMA base stations and multicarrier applications in the HF to 2200 MHz frequency range
- · Broadcast drivers.

DESCRIPTION

10 W LDMOS power transistor for base station applications at frequencies from HF to 2200 MHz.

QUICK REFERENCE DATA

Typical RF performance at $T_h = 25$ °C in a common source test circuit.

MODE OF OPERATION	f	V _{DS}	P _L	G _p	η _D	d _{im}
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)
CW, class-AB (2-tone)	f ₁ = 2000; f ₂ = 2000.1	26	10 (PEP)	12.5	36.5	-32

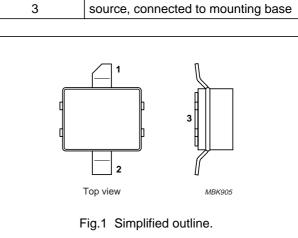
LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DS}	drain-source voltage		_	75	V
V _{GS}	gate-source voltage		_	±15	V
I _D	drain current (DC)		_	2.2	А
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	200	°C

CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.



PINNING - SOT538A

PIN

1

2

drain

gate

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-h}	thermal resistance from junction to heatsink	T _{mb} = 25 °C; note 1	9	K/W

Note

1. Thermal resistance is determined under RF operating conditions.

CHARACTERISTICS

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)DSS}	drain-source breakdown voltage	$V_{GS} = 0; I_D = 0.2 \text{ mA}$	65	-	-	V
V _{GSth}	gate-source threshold voltage	V _{DS} = 10 V; I _D = 20 mA	4	-	5	V
I _{DSS}	drain-source leakage current	$V_{GS} = 0; V_{DS} = 26 V$	-	-	1.5	μA
I _{DSX}	on-state drain current	$V_{GS} = V_{GSth} + 9 V; V_{DS} = 10 V$	2.8	-	-	A
I _{GSS}	gate leakage current	$V_{GS} = \pm 15 \text{ V}; V_{DS} = 0$	-	-	40	nA
9 _{fs}	forward transconductance	V _{DS} = 10 V; I _D = 0.75 A	-	0.5	-	S
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 0.75 A	-	1.2	-	Ω
C _{is}	input capacitance	$V_{GS} = 0; V_{DS} = 26 V; f = 1 MHz$	-	11	-	pF
C _{os}	output capacitance	$V_{GS} = 0; V_{DS} = 26 V; f = 1 MHz$	-	9	-	pF
C _{rs}	feedback capacitance	V _{GS} = 0; V _{DS} = 26 V; f = 1 MHz	-	0.5	-	pF

APPLICATION INFORMATION

RF performance in a common source class-AB circuit. $T_h = 25$ °C; $R_{th mb-h} = 0.4$ K/W, unless otherwise specified.

MODE OF OPERATION	f	V _{DS}	I _{DQ}	P _L	G _p	ղը	d _{im}
	(MHz)	(V)	(mA)	(W)	(dB)	(%)	(dBc)
CW, class-AB (2-tone)	f ₁ = 2000; f ₂ = 2000.1	26	85	10 (PEP)	>11.8	>33	≤–26

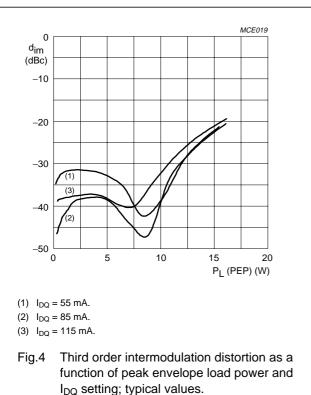
Ruggedness in class-AB operation

The BLF2043 is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 26 V; f = 2000 MHz at rated load power.

MCE018 0 d_{im} (dBc) η_{D} (%) -20 d₃ d₅ -40 d7 -60 -80 0 5 10 15 P_L (PEP) (W)

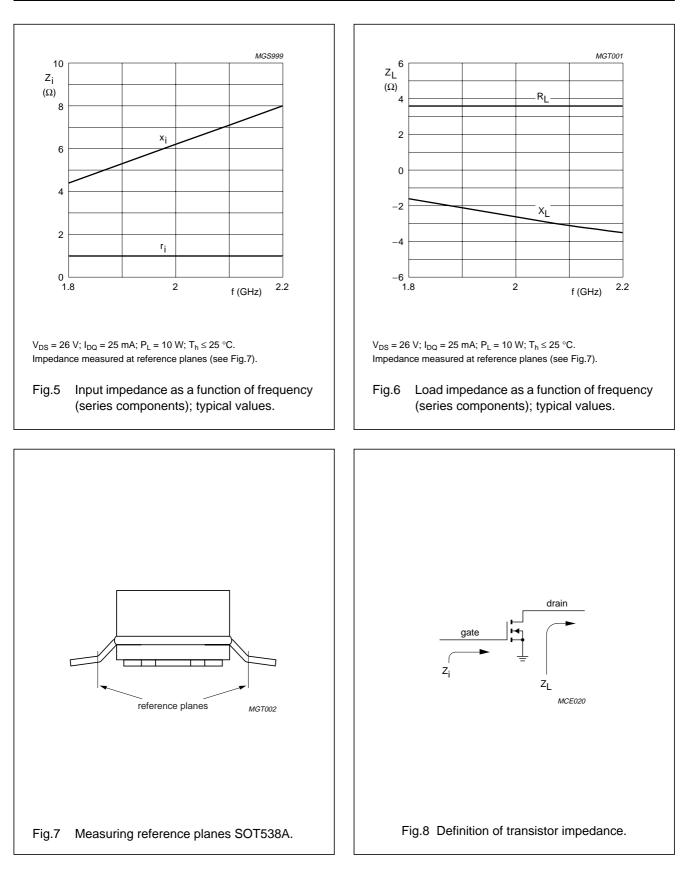
Intermodulation distortion as a function of Fig.3 peak envelope load power; typical values.

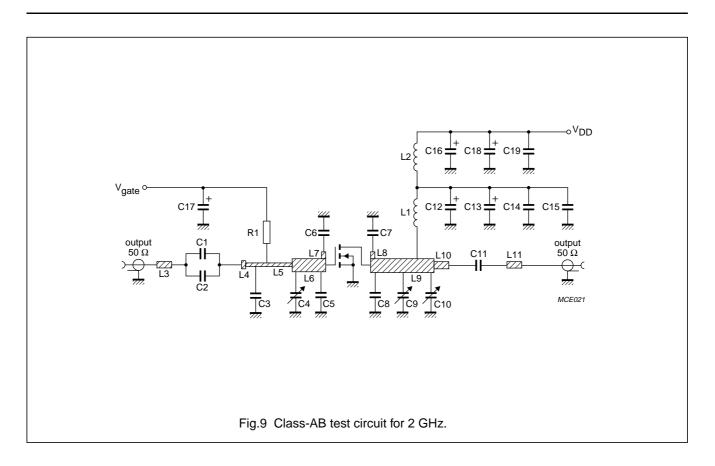
MCE017 60 15 Gp G_p (dB) 40 10 η_D 20 5 0 0 0 5 10 15 20 P_L (PEP) (W) Fig.2 Power gain and efficiency as functions of peak envelope load power; typical values.



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List of components (see Figs 8 and 9)

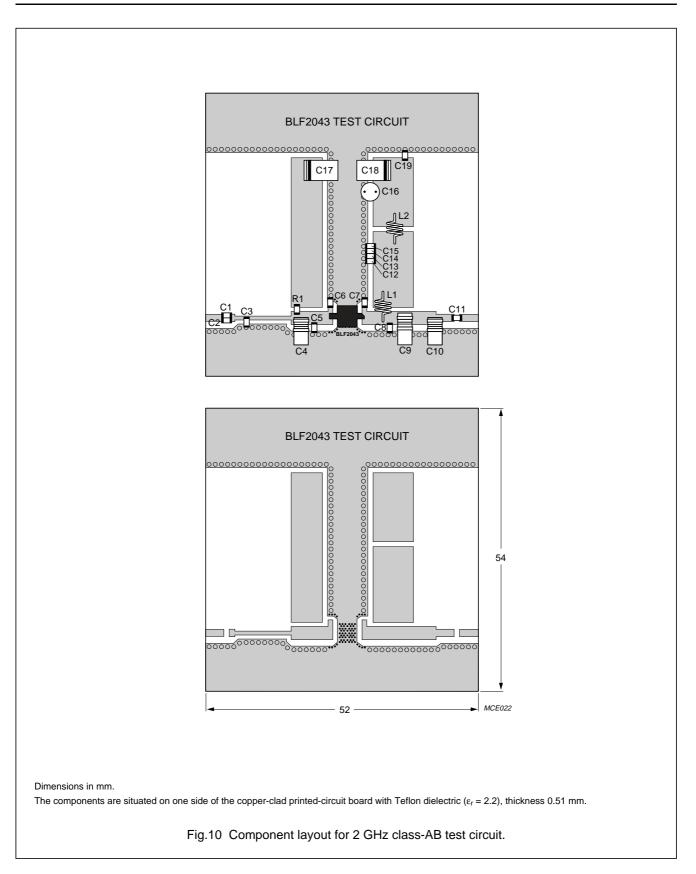
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C2	multilayer ceramic chip capacitor; note 1	6.8 pF		
C3	multilayer ceramic chip capacitor; note 1	1.0 pF		
C4, C10, C11	tekelec variable capacitor; type 37271	0.6 to 4.5 pF		
C5, C7	multilayer ceramic chip capacitor; note 1	2.0 pF		
C6	multilayer ceramic chip capacitor; note 1	2.7 pF		
C8	multilayer ceramic chip capacitor; note 1	0.2 pF		
C9	multilayer ceramic chip capacitor; note 1	0.6 to 4.5 pF		
C12	multilayer ceramic chip capacitor; note 1	10 pF		
C13	multilayer ceramic chip capacitor; note 1	51 pF		
C14	multilayer ceramic chip capacitor; note 1	120 pF		
C15	multilayer ceramic chip capacitor	100 nF		2222 581 16641
C16	electrolytic capacitor	100 μF; 63 V		2222 037 58101
C17, C18	tantalum SMD capacitor	10 μF; 35 V		
C19	multilayer ceramic chip capacitor; note 2	1 nF		
L1, L2	3 turns enamelled 0.5 mm copper wire		3 loops; d = 3 mm length = 3 mm	
L3	stripline; note 3	50 Ω	3.5 imes 1.5 mm	
L4	stripline; note 3	50 Ω	1.0 × 1.5 mm	
L5	stripline; note 3	73.2 Ω	$5 \times 2 \text{ mm}$	
L6	stripline; note 3	31 Ω	$11.0 \times 0.8 \text{ mm}$	
L7, L8	stripline; note 3	64.7 Ω	1.5 × 1.0 mm	
L9	stripline; note 3	31 Ω	$14.4 \times 3.0 \text{ mm}$	
L10, L11	stripline; note 3	50 Ω	3.5 imes 1.5 mm	
R1	metal film resistor	2.2 kΩ; 0.6 W		

Notes

1. American Technical Ceramics type 100A or capacitor of same quality.

2. American Technical Ceramics type 100B or capacitor of same quality.

3. The striplines are on a double copper-clad printed-circuit board with Rogers 5880 dielectric (ϵ_r = 2.2); thickness 0.51 mm.

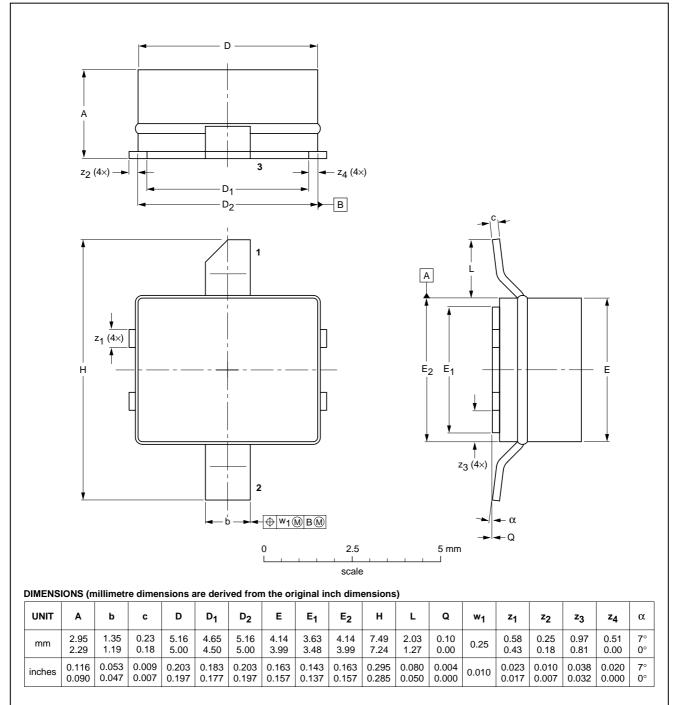


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PACKAGE OUTLINE

Ceramic surface mounted package; 2 leads



OUTLINE	REFERENCES			EUROPEAN			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT538A					$\square $	-00-03-03 02-08-20	

SOT538A

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DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Contact information

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